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The document following this cover page is marked as “Cypress” document as this is the company that originally developed the product. Please note that Infineon will continue to offer the product to new and existing customers as part of the Infineon product portfolio.

Continuity of document content

The fact that Infineon offers the following product as part of the Infineon product portfolio does not lead to any changes to this document. Future revisions will occur when appropriate, and any changes will be set out on the document history page.

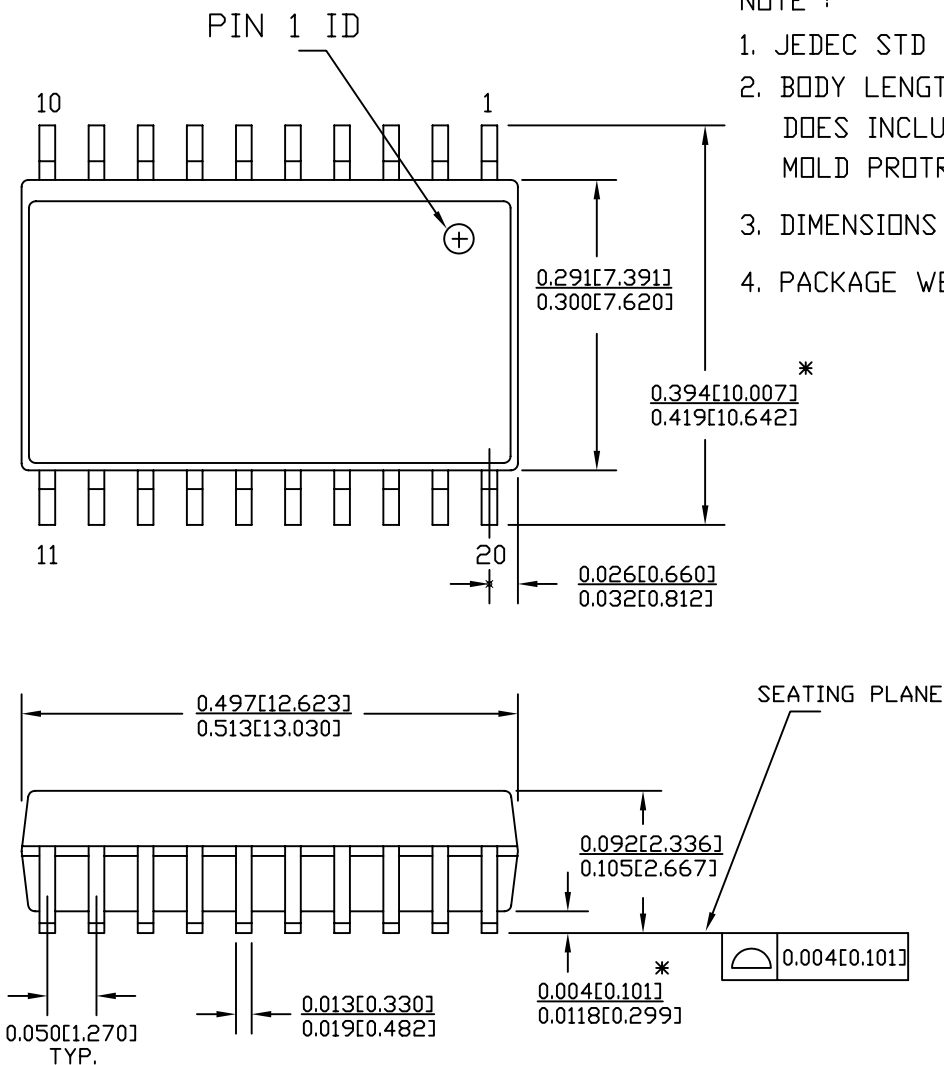
Continuity of ordering part numbers

Infineon continues to support existing part numbers. Please continue to use the ordering part numbers listed in the datasheet for ordering.

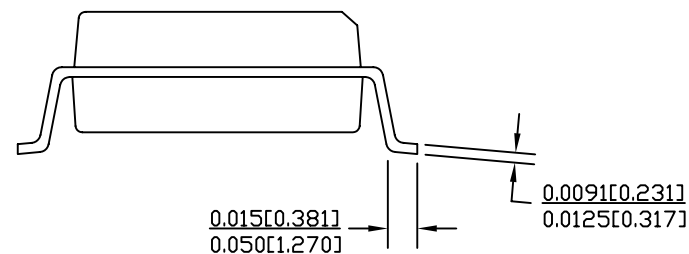
20 Lead (300 Mil) SOIC – S5

NOTE :

1. JEDEC STD REF MO-119
2. BODY LENGTH DIMENSION DOES NOT INCLUDE MOLD PROTRUSION/END FLASH,BUT DOES INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD PROTRUSION/END FLASH SHALL NOT EXCEED 0.010 in (0.254 mm) PER SIDE
3. DIMENSIONS IN INCHES MIN.
MAX.
4. PACKAGE WEIGHT 0.55gms



PART #	
S20.3	STANDARD PKG.
SZ20.3	LEAD FREE PKG.



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PACKAGE
CODE(S)

SEE NOTE



CYPRESS
Company Confidential

TITLE
PACKAGE OUTLINE, 20L SOIC .513X.300X.0932
INCHES

SPEC NO.
51-85024

REV
#F

SCALED TO FIT

N/A

SHEET 1 OF 2

REV	ECN	Origin of Change	Description of Change
**	N/A	-	NA
*A	49381	TZWTMP2	CHG. TITLE/ CHG. DIM.S AT *
*B	128907	TSV	ADD MM DIM./ ADD JEDEC #/ ADD SZ PART #/ ADD PKG. WEIGHT
*C	413084	ONG	ADD NOTES - JEDEC REFERENCE MO-119 -MOLD PROTRUSION/END FLASH INFORMATION
*D	2868899	TZWTMP3	CHANGED TEMPLATE, CHANGE TITLE FROM 20LD (300 MIL) SOIC PKG OUTLINE TO PACKAGE OUTLINE, 20L SOIC .513X.300X.0932 INCHES
*E	3146953	QADTMP1	ECN SUNSET NO CHANGE
*F	4253735	KTQAD/ XANC	SUNSET REVIEW. CHANGED DRAWING TEMPLATE.

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SHEET 2 OF 2